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| APPLICATION NO.                      | FILING DATE         | FIRST NAMED INVENTOR   | ATTORNEY DOCKET NO. | CONFIRMATION NO. |  |
|--------------------------------------|---------------------|------------------------|---------------------|------------------|--|
| 10/808,111                           | 03/24/2004          | Christian L. Belady    | 200316167-1 4172    |                  |  |
| 22879 7:                             | 590 01/05/2006      |                        | EXAMINER            |                  |  |
| HEWLETT P                            | ACKARD COMPAN       | DATSKOVSKIY, MICHAEL V |                     |                  |  |
| P O BOX 2724                         | 00, 3404 E. HARMON' | Y ROAD                 |                     |                  |  |
| INTELLECTUAL PROPERTY ADMINISTRATION |                     |                        | ART UNIT            | PAPER NUMBER     |  |
| FORT COLLIN                          | IS. CO 80527-2400   | 2835                   |                     |                  |  |

DATE MAILED: 01/05/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

|   |  | Applicat   | ion No.   | Applicant(s)  |           |
|---|--|--|---|---|-----------|
| Office Action Summary   |  | 10/808,1   | 111   | BELADY ET AL.   |           |
|   |  | Examine  | r   | Art Unit  |           |
|   |  | Michael  | V. Datskovskiy  | 2835  |           |
| Period fo   | The MAILING DATE of this commun  | ication appears on th  | e cover sheet with the d  | correspondence ad   | dress     |
| A SH<br>WHIC<br>- Exter<br>after<br>- If NC<br>- Failu<br>Any | ORTENED STATUTORY PERIOD F CHEVER IS LONGER, FROM THE N nsions of time may be available under the provisions SIX (6) MONTHS from the mailing date of this come period for reply is specified above, the maximum s re to reply within the set or extended period for reply reply received by the Office later than three months ed patent term adjustment. See 37 CFR 1.704(b).   | MAILING DATE OF T<br>s of 37 CFR 1.136(a). In no e<br>nunication.<br>atutory period will apply and o<br>will, by statute, cause the ap | THIS COMMUNICATION  INVENT, however, may a reply be ting  will expire SIX (6) MONTHS from  poplication to become ABANDONE | N.<br>nely filed<br>the mailing date of this co<br>D (35 U.S.C. § 133). |           |
| Status  |  |  |   |   |           |
|   | Responsive to communication(s) file. This action is <b>FINAL</b> . Since this application is in condition closed in accordance with the pract  | 2b)⊠ This action is for allowance excep  | non-final.<br>ot for formal matters, pro  |   | merits is |
| Dispositi   | ion of Claims  |  |   |   |           |
| 5)⊠<br>6)⊠<br>7)⊠<br>8)□<br><b>Applicat</b> i                 | Claim(s) 1-29 is/are pending in the 4a) Of the above claim(s) is/a Claim(s) 28 and 29 is/are allowed. Claim(s) 1,2,4-6,8,12 and 18-25 is/a Claim(s) 3,7,9-11,13-17,26 and 27 is/a Claim(s) are subject to restriction Papers The specification is objected to by the the drawing(s) filed on 24 March 20 Applicant may not request that any objection is a control of the control | are withdrawn from content rejected. s/are objected to. ction and/or election the Examiner.  04 is/are: a)⊠ accented to the drawing(s) | requirement.<br>epted or b)⊡ objected t<br>be held in abeyance. Se  | e 37 CFR 1.85(a).   |           |
| 11)   | Replacement drawing sheet(s) including<br>The oath or declaration is objected t  | -  | =   | =   |           |
| ·   | under 35 U.S.C. § 119  | •  |   |   |           |
| 12)[_]<br>a)  | Acknowledgment is made of a claim  All b) Some * c) None of:  1. Certified copies of the priority  2. Certified copies of the priority  3. Copies of the certified copies application from the Internation   | documents have be documents have be of the priority documental Bureau (PCT Ru  | en received.<br>en received in Applicati<br>nents have been receive<br>ule 17.2(a)).                                      | ion No<br>ed in this National   | Stage     |
| 2) Notice 3) Information                                      | t(s) se of References Cited (PTO-892) se of Draftsperson's Patent Drawing Review (I mation Disclosure Statement(s) (PTO-1449 or r No(s)/Mail Date  | -  | 4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:   |   | D-152)    |

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 2. Claims 1-2, 4-6, 8, 12, 18-24 and 25 are rejected under 35 U.S.C. 102(e) as being anticipated by Kirshberg et al (US Patent 6,976,527).

Kirshberg et al teach a loop thermosyphon system, Figs. 1-4, comprising:

a semiconductor die (col. 3, lines 4-10 and 65-67) having a plurality of microchannels; a condenser 12 in fluid communication with grooves 24; said grooves 24 are shaped to create a wicking structure for preferential cooling fluid flow along one direction toward the condenser 12 and further toward heat generating region of the semiconductor die.

Kirshberg et al teach furthermore said system further comprising an input fluid conduit 16 for coupling fluid from the condenser 12 to the semiconductor die, said input conduit 16 having a wicking structure 26 being internal to said conduit 16. Kirshberg et al teach furthermore said system further comprising a plate 22 coupled with the die to seal the microchannels such that fluid flows through the microchannels. Kirshberg et al teach furthermore said system, further comprising an output fluid conduit 14, for coupling fluid

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from the microchannels to the condenser, wherein the wicking structure comprising thermally conductive material (col. 2, lines 41-60). Regarding to claims 22-24 and 25: The method steps are necessitated by the device structure as Kirshberg et al disclosed it.

## Allowable Subject Matter

- 3. Claims 28-29 are allowed.
- 4. Claims 3, 7, 9-11, 13-17 and 26-27 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.
- 5. The following is a statement of reasons for the indication of allowable subject matter: Said system further comprising: an input header (claim 3); an output header (claim 7); the wicking structure comprising copper (claim 9); the wicking structure being selected from the group comprising porous-like material, powder, fiber, screen and mixtures thereof (claims 10-11); said system further comprising: blocking material forming at least one orifice at an input to at least one microchannels (claims 13-14 and 26); the condenser being arranged above the die (claim 15); the system further comprising fluid-restrictive material at least one of the microchannels for preferential fluid flow along one direction (claims 16-17 and 27-29);
- 6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure: Joshi et al (US Patent Application Publication 2002/0179284 A1) and O'Connor et al (US Patent 6,501,654).

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7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michael V. Datskovskiy whose telephone number is (571) 272-2040. The examiner can normally be reached on 8-4:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Lynn Feild can be reached on (571) 272-2092. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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Michael V Datskovskiy Primary Examiner Art Unit 2835

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12/28/2005